MBRA130LT3

Surface Mount Schottky Power Rectifier

SMA Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop

Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, V_O at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Lead Indicated by Either Notch in Plastic Body or Polarity Band
- Available in 12 mm Tape, 5000 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Device Meets MSL1 Requirements
- ESD Ratings: Machine Model, C (>400 V) Human Body Model, 3B (>8000 V)
- Marking: B1L3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Forward Current (At Rated V _R , T _C = 105°C)	I _O	1.0	Α
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 100 kHz, $T_C = 105^{\circ}C$)	I _{FRM}	2.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	25	Α
Storage Temperature	T _{stg}	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs



http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 30 VOLTS



SMA CASE 403D PLASTIC

MARKING DIAGRAM



B1L3 = Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]		
MBRA130LT3	SMA	5000/Tape & Reel		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit	l
Thermal Resistance — Junction–to–Lead (Note 1.) Thermal Resistance — Junction–to–Ambient (Note 1.)	$R_{ heta JL} \ R_{ heta JA}$	35 86	°C/W	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2.)		V _F	T _J = 25°C	T _J = 100°C	Volts
see Figure 2	$(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.41 0.47	0.35 0.43	
Maximum Instantaneous Reverse Current		I _R	T _J = 25°C	T _J = 100°C	mA
see Figure 4	$(V_R = 30 \text{ V})$ $(V_R = 15 \text{ V})$		1.0 0.4	25 12	

- Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.
 Pulse Test: Pulse Width ≤ 250 μs, Duty Cycle ≤ 2.0%.

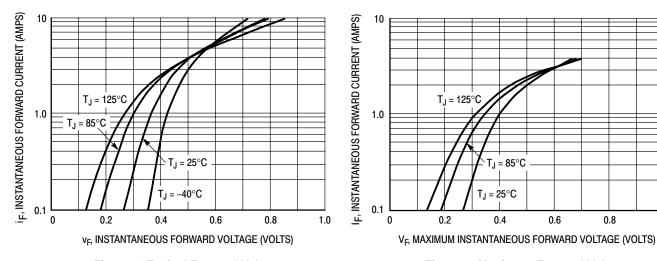


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

1.0

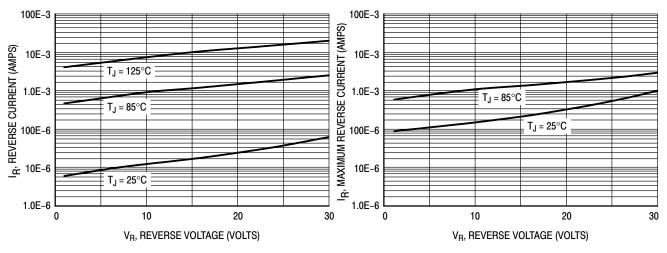
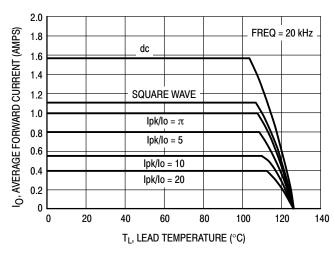


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

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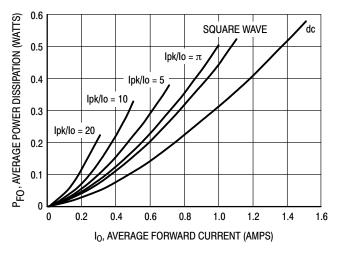


Figure 5. Current Derating

Figure 6. Forward Power Dissipation

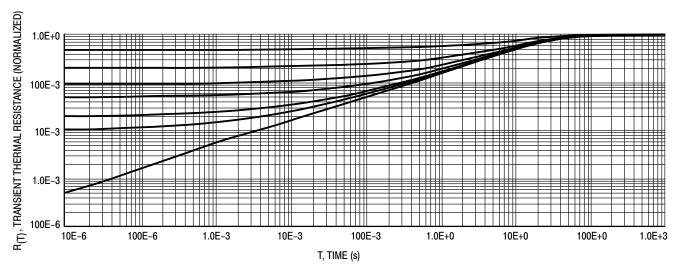


Figure 7. Thermal Response

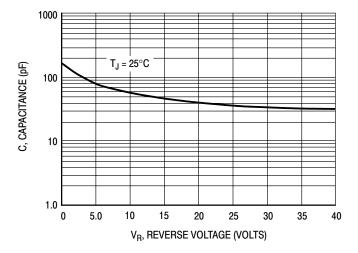
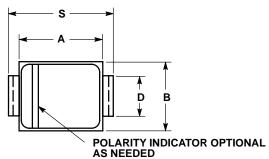


Figure 8. Capacitance

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PACKAGE DIMENSIONS

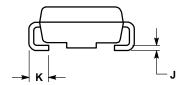
SMA CASE 403D-02 ISSUE A

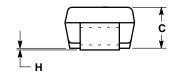


NOTES:

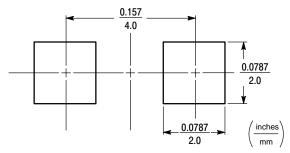
- DIMENSIONING AND TOLERANCING PER ANSI
 VIA EM 1000
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN MAX		
Α	0.160	0.180	4.06	4.57	
В	0.090	0.115	2.29	2.92	
С	0.075	0.095	1.91	2.41	
D	0.050	0.064	1.27	1.63	
H	0.002	0.006	0.05	0.15	
_	0.006	0.016	0.15	0.41	
K	0.030	0.060	0.76	1.52	
S	0.190	0.220	4.83	5.59	





SOLDERING FOOTPRINT*



SMA FOOTPRINT

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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